

EM918 Solder Paste

Lead-Free, No-Clean

Product Description

Kester EM918 Solder Paste is a lead-free, halide-free, air and nitrogen reflowable ICT pin probeable, no-clean solder paste specifically designed for the thermal requirements of lead free alloys, including the Sn96.5Ag3.0Cu0.5 alloy. EM918 is capable of stencil printing downtimes up to 60 minutes with an effective first print down to 20 mils without kneading. EM918 also exhibits excellent continual printability for the fine pitch (0.4 mm/16 mils) and is able to print at high speeds up to 6 in/s (150 mm/s). EM918 offers excellent cosmetic appearance in the reflowed solder joints with smooth solder and light colored residues, closely resembling tin-lead joints. EM918 is classified as Type ROL0 flux under IPC ANSI/J-STD-004A Joint Industry Standard.

Performance Characteristics:

- Lead-free
- No-clean
- Capable of print speeds up to 150 mm/sec (6 in/sec)
- Extended stencil life (process dependent)
- Halide-free chemistry
- Excellent release from stencil
- Excellent printing characteristics on 0.4 mm (16 mil) pitch
- Clean cosmetic aesthetics after reflow
- Resistant to slump
- Stable tack life
- Classified as ROL0 per J-STD-004A

Standard Applications:

- Stencil Printing 88.5% Metal for Mesh -325/+500
- Stencil Printing 88.0% Metal for Mesh -325/+500

RoHS Compliance

This product meets the requirements of the Restriction of Hazardous Substances (RoHS) Directive, 2011/65/EU for the stated banned substances







Physical Properties

(Data given for Sn96.5Ag3.0Cu0.5, 88.5% metal, -325+500 mesh)

Viscosity (typical): 1950 poise

Malcom Viscometer @ 10 rpm and 25 °C

Initial Tackiness (typical): 33 grams

Tested to J-STD-005, IPC-TM-650, Method 2.4.44

Slump Test: Pass

Tested to J-STD-005, IPC-TM-650, Method 2.4.35

Solder Ball Test: Preferred

Tested to J-STD-005, IPC-TM-650, Method 2.4.43

Wetting Test: Pass

Tested to J-STD-005, IPC-TM-650, Method 2.4.45

Reliability Properties

Copper Mirror Corrosion: Low

Tested to J-STD-004, IPC-TM-650, Method 2.3.32

Corrosion Test: Low

Tested to J-STD-004, IPC-TM-650, Method 2.6.15

Chloride and Bromides: None Detected

Tested to J-STD-004, IPC-TM-650, Method 2.3.35

Fluorides by Spot Test: Pass

Tested to J-STD-004, IPC-TM-650, Method 2.3.35.1

Surface Insulation Resistivity (SIR), (typical): Pass

Tested to J-STD-004, IPC-TM-650, Method 2.6.3.3

	Blank	EM918
Day 1	6.6*10 ⁹ Ω	7.1*10 ⁸ Ω
Day 4	5.0*10 ⁹ Ω	6.3*10 ⁸ Ω
Day 7	3.8*10 ⁹ Ω	6.2*10 ⁸ Ω







Availability

EM918 is available in Sn96.5Ag3.0Cu0.5 alloy. Type 3 mesh is recommended, but different powder particle size distributions are available for standard and fine pitch applications. EM918 is also compatible with other SnAgCu alloys in a similar melting range to the listed alloys and Sn96.5Ag3.5. For specific packaging information, see Kester's Paste Packaging Chart for available sizes. The appropriate combination depends on process variables and the specific application.

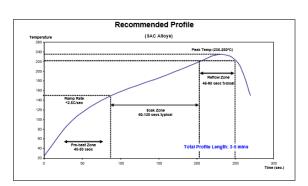
Printing Parameters

Squeegee Blade	80 to 90 durometer polyurethane or stainless steel	
Squeegee Speed	40 to 150 mm/sec (1.6 to 6 in/sec) recommended	
Stencil Material	Stainless Steel, Molybdenum, Nickel Plated, Brass	
Temperature/Humidity	Optimal ranges are 21 to 25 °C (70 to 77 °F) and 35 to 65% RH	

Optimal printing parameters may be different from recommendations above based on your operating conditions, customer expectations and experience. The ranges above are meant to act as a guideline based on Kester testing.

Recommended Reflow Profile

The recommended reflow profile for EM918 made with the SAC and SnAg3.5 alloys is shown here. This profile is simply a guideline. Since EM918 is a highly active solder paste, it can solder effectively over a wide range of profiles. Your optimal profile may be different from the one shown based on your oven, board and mix of defects. Please contact Kester Technical Support if you need additional profiling advice.



Cleaning

EM918 is a no-clean formula. The residues do not need to be removed for typical applications. Although EM918 is designed for no-clean applications, its residues can be easily removed using automated cleaning equipment (in-line or batch) with a variety of readily available cleaning agents. Call Kester Technical Support for details.





TECHNICAL DATA SHEET

Recycling Services

We provide safe and efficient recycling services to help companies meet their environmental and legislative requirements and at the same time, maximize the value of their waste streams.

Our service collects solder dross, solder scrap, and various forms of solder paste waste. Please contact your local sales representative for recycling capabilities in your area or <u>link here</u>.



Storage, Handling and Shelf Life

Refrigeration is the recommended optimum storage condition for solder paste to maintain consistent viscosity, reflow characteristics and overall performance. EM918 should be stabilized at room temperature prior to printing. EM918 should be kept at standard refrigeration conditions, 0 to 10 °C (32 to 50 °F). Please contact Kester Technical Support if you require additional advice with regard storage and handling of this material. Shelf life is 6 months from date of manufacture when handled properly and held at 0 to 10 °C (32 to 50 °F).

Health and Safety

This product, during handling or use, may be hazardous to your health or the environment. Read the Safety Data Sheet and warning label before using this product. Safety Data Sheets are available at this <u>link</u>.

Contact Information

To confirm this document is the most recent version, please contact Assembly@MacDermidAlpha.com

North America	Europe	Asia Pacific
109 Corporate Blvd.	Unit 2, Genesis Business Park	8/F., Paul Y. Centre
South Plainfield, NJ 07080, USA	Albert Drive	51 Hung To Road
1.800.253.7837	Woking, Surrey, GU21 5RW, UK	Kwun Tong, Kowloon, Hong Kong
	44.01483.758400	852.3190.3100

Also read carefully warning and safety information on the Safety Data Sheet. This data sheet contains technical information required for safe and economical operation of this product. READ IT THOROUGHLY PRIOR TO PRODUCT USE. Emergency safety directory assistance: US 1 202 464 2554, Europe + 44 1235 239 670, Asia + 65 3158 1074, Brazil 0800 707 7022 and 0800 172 020, Mexico 01800 002 1400 and (55) 5559 1588

DISCLAIMER: All statements, technical information and recommendations contained herein are based on tests we believe to be reliable, but the accuracy or completeness thereof is not guaranteed. No statement or recommendation shall constitute a representation unless set forth in an agreement signed by officers of seller and manufacturer. NO WARRANTY OF MERCHANTABILITY, WARRANTY OF FITNESS FOR A PARTICULAR PURPOSE OR ANY IMPLIED WARRANTY IS MADE. The following warranty is made in lieu of such warranties and all other warranties, express, implied, or statutory. Products are warranted to be free from defects in material and workmanship at the time sold. The sole obligation of seller and manufacturer under this warranty shall be to replace any noncompliant product at the time sold. Under no circumstances shall manufacturer or seller be liable for any loss, damage or expense, direct, indirect, incidental or consequential, arising out of the inability to use the product. Notwithstanding the foregoing, if products are supplied in response to a customer request that specifies operating parameters beyond those stated above, or if products are used under conditions exceeding said parameters, the customer by acceptance or use thereof assumes all risk of product failure and of all direct, incidental and consequential damages that may result from use of the products under such conditions, and agrees to exonerate, indemnify, defend and hold harmless MacDermid, Incorporated and its affiliates therefrom. No suggestion for product use nor anything contained herein shall be construed as a recommendation to use any product in a manner that infringes any patent or other intellectual property rights, and seller and manufacturer assume no responsibility or liability for any such infringement.

© 2019 MacDermid, Inc. and its group of companies. All rights reserved. "(R)" and "TM" are registered trademarks of MacDermid, Inc. and its group of companies in the United States and/or other countries.

